



Material Content Data Sheet



Halogen-Free

Sales Product Name	TLE4263-2ES	Issued	08. February 2022
MA#	MA003914236		
Package	PG-DSO-8-27	Weight*	84.53 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	3.095	3.66	3.66	36618	36618
leadframe	inorganic material	phosphorus	7723-14-0	0.009	0.01		108	
	non noble metal	zinc	7440-66-6	0.036	0.04		430	
	non noble metal	iron	7439-89-6	0.728	0.86		8609	
	non noble metal	copper	7440-50-8	29.548	34.96	35.87	349550	358697
wire	noble metal	gold	7440-57-5	0.147	0.17	0.17	1735	1735
encapsulation	organic material	carbon black	1333-86-4	0.096	0.11		1136	
	plastics	epoxy resin	-	4.418	5.23		52261	
	inorganic material	silicondioxide	60676-86-0	43.504	51.47	56.81	514658	568055
leadfinish	non noble metal	tin	7440-31-5	0.695	0.82	0.82	8223	8223
plating	noble metal	silver	7440-22-4	0.725	0.86	0.86	8571	8571
glue	plastics	epoxy resin	-	0.383	0.45		4525	
	noble metal	silver	7440-22-4	1.148	1.36	1.81	13576	18101
*deviation	< 10%				Sum in total:	100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption.

Company	Infineon Technologies AG
Address	81726 Neubiberg
Internet	www.infineon.com